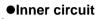
# S4603

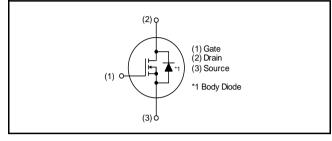
## N-channel SiC power MOSFET bare die

V <sub>DSS</sub>	1200V
R <sub>DS(on)</sub> (Typ.)	36mΩ
Ι <sub>D</sub> <sup>*1</sup>	43A

#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive





### Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives

## ●Absolute maximum ratings (T<sub>vj</sub> = 25°C unless otherwise specified)

	- ,				
Parameter		Symbol	Value	Unit	
Drain - source voltage			V <sub>DSS</sub>	1200	V
Continuous drain and	$\lambda = \lambda$	$T_c = 25^{\circ}C$	ا <sub>D</sub> , I <sub>S</sub> <sup>*1</sup>	43	А
source current	$V_{GS} = V_{GS_{on}}$	$T_c = 100^{\circ}C$	I <sub>D</sub> , I <sub>S</sub>	30	А
Pulsed drain current	$V_{GS} = V_{GS_{on}}$	$T_c = 25^{\circ}C$	I <sub>D,pulse</sub> *2	84	А
Body diode pulsed forw	ard current	$V_{GS} = 0 V$	*1,*3 I <sub>S,pulse</sub>	43	А
Body diode surge forward current $T_c = 25^{\circ}$		$T_c = 25^{\circ}C$	I <sub>S,pulse</sub> *1,*4	84	А
Gate - source voltage (DC)		V <sub>GSS</sub>	-4 to +21	V	
Gate - source surge voltage (t <sub>surge</sub> < 300ns)		V <sub>GSS_surge</sub> *5	-4 to +23	V	
Recommended turn-on gate - source drive voltage		V <sub>GS_on</sub> *6	+15 to +18	V	
Recommended turn-off gate - source drive voltage		$V_{GS_{off}}$	0	V	
Virtual junction temperature		T <sub>vj</sub>	175	°C	
Range of storage tempe	erature		T <sub>stg</sub>	-40 to +175	°C

## •Electrical characteristics ( $T_{vj}$ = 25°C unless otherwise specified)

Deremeter	Sympol	Conditions		L La it		
Parameter	Symbol		Min.	Тур.	Max.	Unit
Drain - Source breakdown		$V_{GS} = 0 V, I_{D} = 9.2 mA$				V
voltage		$T_{vj} = 25^{\circ}C$	1200	-	-	
7 0 / //		$V_{GS} = 0 V, V_{DS} = 1200V$				
Zero Gate voltage Drain current	I <sub>DSS</sub>	T <sub>vj</sub> = 25°C	-	1	80	μA
		T <sub>vj</sub> = 150°C	-	10	-	
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS} = +21V$ , $V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current		$V_{GS} = -4V  , V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}{}^{*7}$	$V_{DS} = 10V, I_{D} = 11.1mA$	2.8	-	4.8	V
		$V_{GS} = 18V, I_{D} = 21A$				
Static Drain - Source on - state resistance	${\sf R}_{\sf DS(on)}$ *8	T <sub>vj</sub> = 25°C	-	36	45	mΩ
		T <sub>vj</sub> = 150°C	-	72	-	
Gate input resistance	$R_G$	f = 1MHz, open drain	-	1	-	Ω



## •Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			l locit
Parameter			Min.	Тур.	Max.	Unit
Transconductance	g <sub>fs</sub> *8	$V_{DS} = 10V, I_{D} = 21A$	-	14	-	S
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0V$	-	2335	-	
Output capacitance	$C_{oss}$	V <sub>DS</sub> = 800V	-	70	-	pF
Reverse transfer capacitance	$C_{rss}$	f = 1MHz	-	5	-	
Effective output capacitance, energy related	$C_{o(er)}$	$V_{GS} = 0V$ $V_{DS} = 0V$ to 800V	-	84	-	pF
Total Gate charge	$Q_g^{*8}$	$V_{DS} = 800V$ $I_{D} = 21A$	-	91	-	
Gate - Source charge	Q <sub>gs</sub> *8	$V_{GS} = 18V$	-	20	-	nC
Gate - Drain charge	Q <sub>gd</sub> *8	See Fig. 1-1, 1-2.	-	24	-	
Turn - on delay time	t <sub>d(on)</sub> *8	$V_{DS} = 800V$	-	8.1	-	
Rise time	t <sub>r</sub> *8	I <sub>D</sub> = 21A V <sub>GS</sub> = +18V / 0V	-	15	-	20
Turn - off delay time	t <sub>d(off)</sub> *8	$R_G = 3.3\Omega$ , L = 250µH E <sub>on</sub> includes diode	-	29	-	ns
Fall time	t <sub>f</sub> *8	reverse recovery $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF	-	9.6	-	
Turn - on switching loss	E <sub>on</sub> *8	See Fig. 2-1, 2-2, 2-3.	-	239	-	
Turn - off switching loss	E <sub>off</sub> *8		-	26	-	μJ



Parameter	Sumbol	Conditions	Values			Unit	
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Forward voltage	$V_{SD}$ *8	$V_{GS} = 0V, I_D = 21A$	-	3.3	-	V	
Reverse recovery time	t <sub>rr</sub> *8	$I_F = 21A$ $V_R = 800V$	-	9.2	-	ns	
Reverse recovery charge	Q <sub>rr</sub> *8	v <sub>R</sub> – 8000 di/dt = 3700A/μs	-	140	-	nC	
Peak reverse recovery current	I <sub>rrm</sub> *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	31	-	А	

●Body diode electrical characteristics (Source-Drain) (T<sub>vi</sub> = 25°C unless otherwise specified)

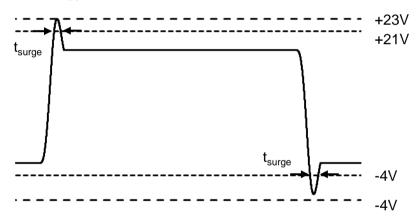
\*1 Limited by maximum  $T_{vi}$  and assumes  $R_{thJC} < 0.85 K/W$ . The value is based on TO-247 package.

\*2 Pulse width and duty cycle are limited by T<sub>vi,max</sub>. The value is based on TO-247 package.

\*3 Only for body-diode, Repititive pulse, PW  $\leq$  1.5µs, Duty cycle  $\leq$  5%

\*4 When used as a protective function, PW  $\leq$  10 $\mu s$ 

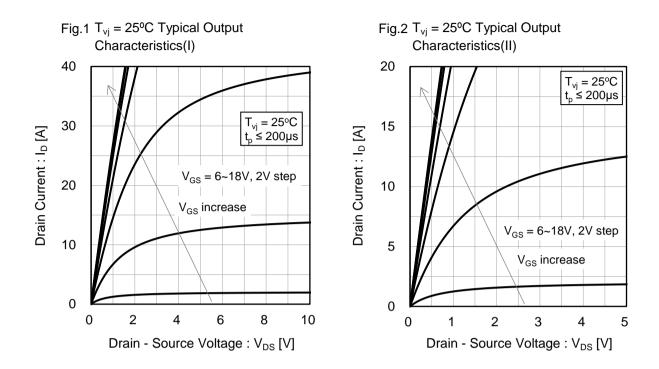
\*5 Example of acceptable V<sub>GS</sub> waveform



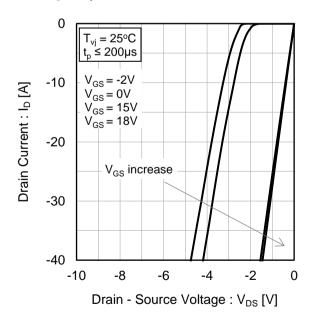
Please note especially when using driver source that V<sub>GSS\_surge</sub> must be in the range of absolute maximum rating.

- \*6 Please be advised not to use SiC-MOSFETs with V<sub>GS</sub> below 10V as doing so may cause thermal runaway.
- \*7 Tested after applying  $V_{GS}$  = 21V for 100ms.
- \*8 Pulsed



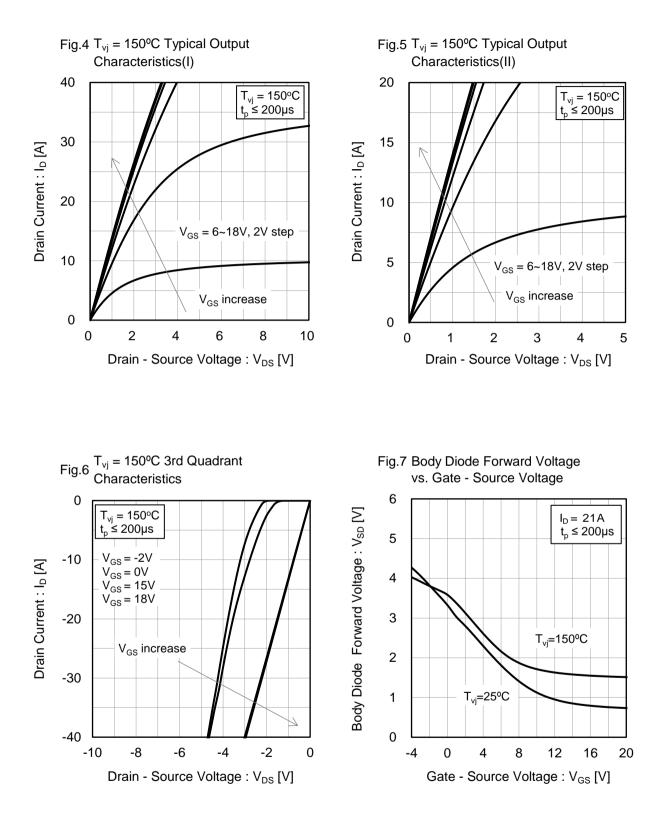


#### Fig.3 $T_{vj}$ = 25°C 3rd Quadrant Characteristics





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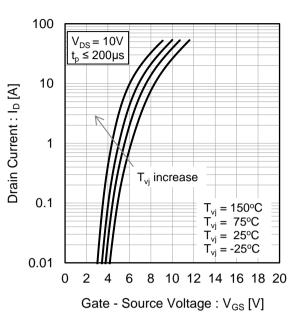
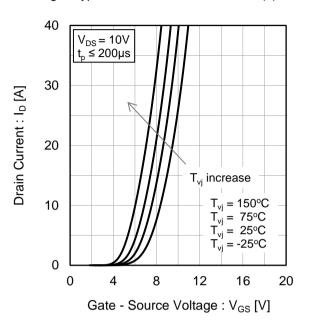


Fig.8 Typical Transfer Characteristics (I)

Fig.9 Typical Transfer Characteristics (II)



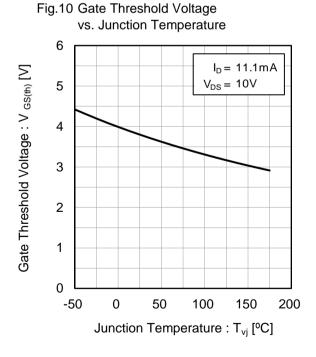
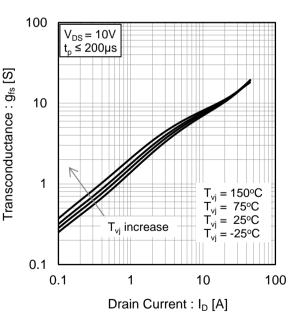
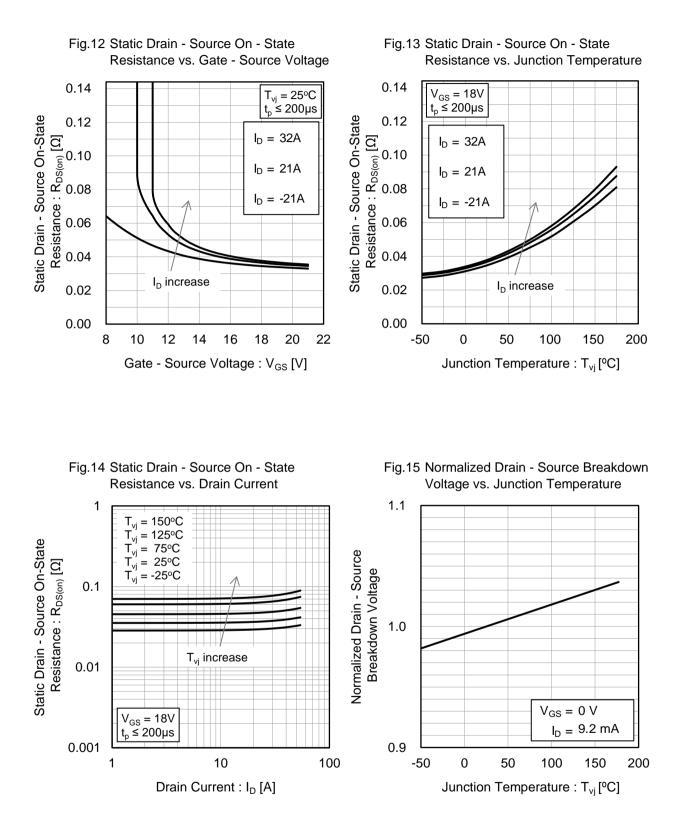


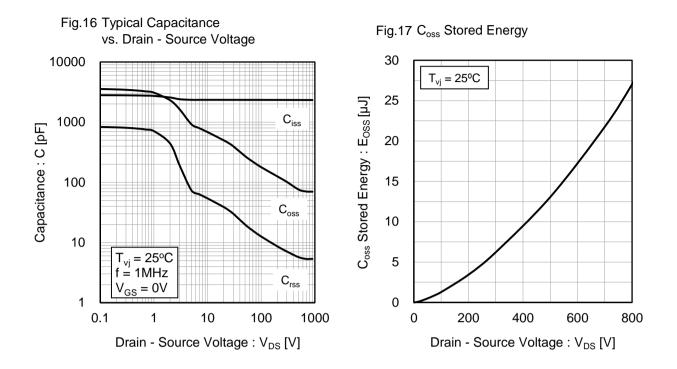
Fig.11 Transconductance vs. Drain Current



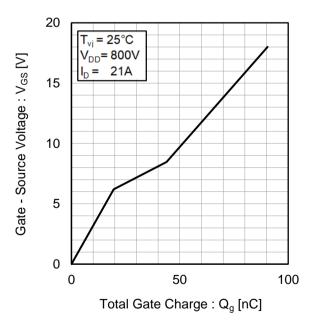




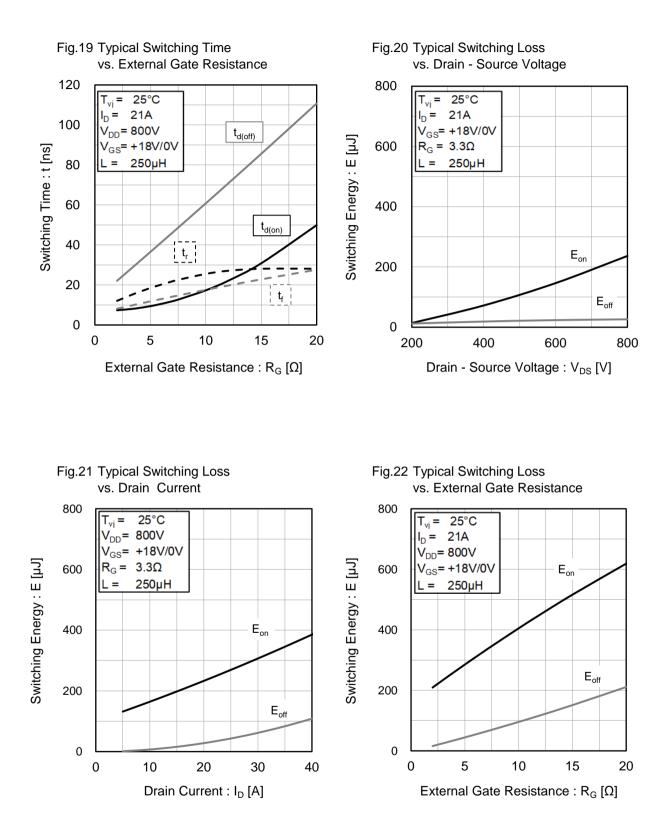




#### Fig.18 Dynamic Input Characteristics

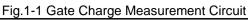








#### Measurement circuits and waveforms



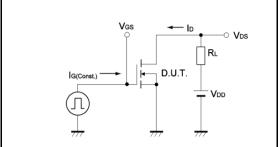
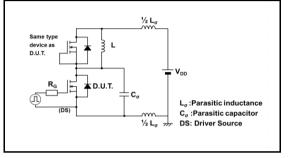


Fig.2-1 Switching Characteristics Measurement Circuit



## Fig.2-3 Waveforms for Switching Energy Loss

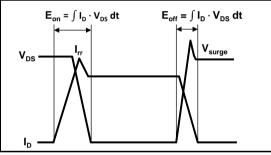
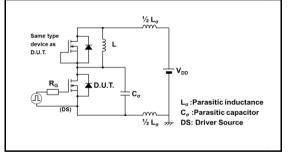
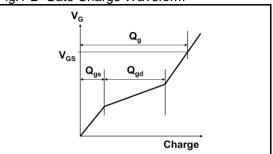


Fig.3-1 Reverse Recovery Time Measurement Circuit



## Fig.1-2 Gate Charge Waveform





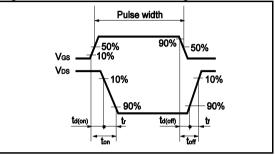
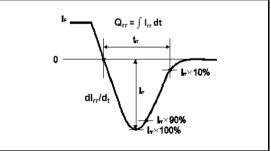


Fig.3-2 Reverse Recovery Waveform



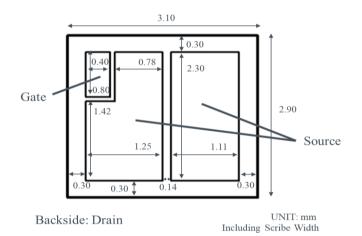


#### Mechanical Parameters

Die Size	3.10 mm x 2.90 mm (Including Scribe Width)
Thickness	150 ± 15 μm
Source Pad Size	See Pad Layout.
Gate Pad Size	0.40 mm x 0.80 mm

Wafer Size	150 mm
Topside Metallization	AlCu
Backside Metallization	Ti-Ni(1.2µm)-Au(0.07µm)
Passivation	Polyimide

#### Pad Layout



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